

RGF1A - RGF1M

Features

- · Glass passivated junction.
- · For surface mounted application.
- Low forward voltage drop.
- · High current capability.
- Easy pick and place.
- High surge current capability.



SMA/DO-214AC COLOR BAND DENOTES CATHODE

Fast Rectifiers

Absolute Maximum Ratings* T_A = 25 ℃ unless otherwise noted

Symbol	Parameter	Value					Units		
		1A	1B	1D	1G	1J	1K	1M	1
V_{RRM}	Maximum Repetitive Reverse Voltage	50	100	200	400	600	800	1000	V
I _{F(AV)}	Average Rectified Forward Current, @ T _L = 125 °C				1.0				Α
I _{FSM}	Non-repetitive Peak Forward Surge Current 8.3 ms Single Half-Sine-Wave	30			А				
T _{stg}	Storage Temperature Range	-65 to +175		•	°C				
T _J	Operating Junction Temperature	ure -65 to +175			°C				

^{*}These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

Thermal Characteristics

Symbol	Parameter	Value	Units
P_{D}	Power Dissipation	1.76	W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient*	85	°C/W
$R_{\theta JL}$	Thermal Resistance, Junction to Lead*	28	°C/W

^{*}Device mounted on FR-4 PCB 0.013 mm.

Electrical Characteristics T_A = 25 °C unless otherwise noted

Symbol	Parameter	Device					Units		
		1A	1B	1D	1G	1J	1K	1M	
V _F	Forward Voltage @ 1.0 A	1.3				V			
t _{rr}	Reverse Recovery Time $I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A}, I_{rr} = 0.25 \text{ A}$	150 250 500				00	ns		
I _R	Reverse Current @ rated V_R $T_A = 25^{\circ}C$ $T_A = 125^{\circ}C$	5.0 100			μ Α μ Α				
Ст	Total Capacitance V _R = 4.0 V, f = 1.0 MHz	8.5		pF					

Fast Rectifiers

(continued)

Typical Characteristics

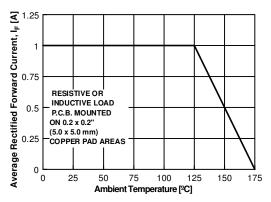


Figure 1. Forward Current Derating Curve

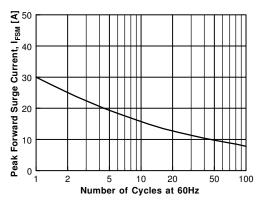


Figure 2. Non-Repetitive Surge Current

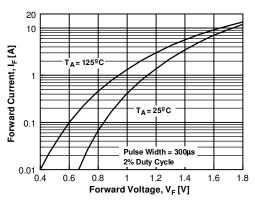


Figure 3. Forward Voltage Characteristics

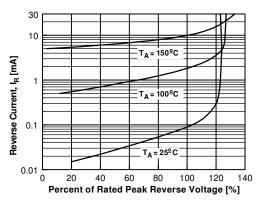


Figure 4. Reverse Current vs Reverse Voltage

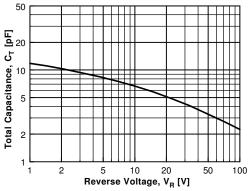


Figure 5. Total Capacitance

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